

VT-840 Temperature Compensated Crystal Oscillator, Voltage Controlled Temperature Compensated Crystal Oscillator

a MICROCHIP company



Description

Vectron's VT-840 Temperature Compensated Crystal Oscillator (TCXO) is a quartz stabilized, clipped sine wave output, analog temperature compensated oscillator, operating off a 1.8, 2.5, 2.8, 3.0 or 3.3 volt supply in a hermetically sealed 2.5x2.0 ceramic package.

Features

- Output Frequencies to 52 MHz
- ±0.5ppm Temperature Stability
- Fundamental Crystal Design
- Optional VCXO Function available
- Low Power
- Hermetically Sealed Ceramic SMD package
- Product is compliant to RoHS directive and fully compatible with lead free assembly

- **Applications**
- Wireless Communications
- GPS
- Base Stations
- · Point to point radios
- Broadband Access
- Test Equipment
- Handsets

Block Diagram



Specifications

Table 1. Electrical Performance					
Parameter	Symbol	Min.	Тур	Max	Units
Output Frequency	f _o	10.000		52.000	MHz
Supply Voltage ¹ , ordering option	V _{DD}	+1.8,	+2.5, +2.8, +3.0	, +3.3	V
Supply Current, 10.000 to 26.000MHz 26.001 to 52.000MHz	I _{DD}			2.0 2.5	mA mA
Operating Temperature, ordering option	T _{OP}	-20)/70, -30/85, -40	/85	°C
Stability Over T _{op} ordering option		±0.5,	±1.0, ±1.5, ±2.0	, ±2.5	ppm
Initial Accuracy ² , "No Adjust" Option				±1.0	ppm
Power Supply Stability				±0.2	ppm
Load Stability				±0.2	ppm
Aging				±1.0	ppm/1st yr
Pull Range, ordering option	TPR	-	±5, ±8, ±10, ±12	2	ppm
Control Voltage to reach Pull Range, 1.8V option +2.5V, +2.8V, +3.0V and +3.3 V options		0.3 0.5		1.5 2.5	V V
Control Voltage Impedance		500			Kohm
Output Level ³	V _o p/p	0.8			V
Output Load			10K II 10pF		
Phase Noise, 26.000MHz 10Hz 100Hz 1kHz 10kHz 100kHz			-85 -110 -130 -148 -148		dBc/Hz
Start Up Time				2	ms

1. The VT-840 power supply pin should be filtered, eg, a 0.1 and 0.01uf capacitor

2. Initial Accuracy is before IR reflow, allow and additional 1ppm shift through 2 reflows and 24 hours.

3. The Output is DC coupled and would normally be AC coupled with a capacitor.

Outline Drawing







Marking Information

Line 1

- XXXX Frequency (Example: 4500 for 45MHz)
- YWW Date Code of Crystal
 - Y Year
 - WW Week of the Year

Line 2

- Yww Date Code of TCXO Y - Year
- ww Week of the Year
- W- Manufacturing Location
 - - Pin 1 Indicator



Recommended Pad Layout

Table 2.	Table 2. Pinout							
Pin #	Symbol	Function						
1	V _c	TCXO Control Voltage or Ground						
2	NC	Make No Connection						
3	GND	Electrical and Lid Ground						
4	Fo	Output Frequency						
5	NC	Make No Connection						
6	V _{DD}	Supply Voltage						

Dimensions in mm

VCXO Function

VCXO Feature: The VT-840 can be ordered with a VCXO function for applications were it will be used in a PLL, or the output frequency needs fine tune or calibration adjustments. This is a high impedance input, 500 Kohm, and can be driven with an op-amp or terminated with adjustable resistors etc. **Pin 1 should not be left floating on the VCXO optional device.**

"No Adjust" Option: In applications were the VT-840 will not be used in a PLL, or the output frequency does not need fine tune adjustments, the best device to use would be a VT-840-xxx-xxx0. By using the "no adjust" option, the circuit is simplified as Vc does not need to be adjusted or set to a predetermined voltage and pin 1 should be grounded (pin 1 can be left open but should not be set to a voltage such as an RF signal or power supply voltage.

Clipped Sine Wave Output

Maximum Ratings

Absolute Maximum Ratings and Handling Precautions

Stresses in excess of the absolute maximum ratings can permanently damage the device. Functional operation is not implied or any other excess of conditions represented in the operational sections of this data sheet. Exposure to absolute maximum ratings for extended periods may adversely affect device reliability.

Although ESD protection circuitry has been designed into the VT-840, proper precautions should be taken when handling and mounting, VI employs a Human Body Model and Charged Device Model for ESD susceptibility testing and design evaluation.

ESD thresholds are dependent on the circuit parameters used to define the model. Although no industry standard has been adopted for the CDM a standard resistance of 1.5kOhms and capacitance of 100pF is widely used and therefor can be used for comparison purposes.

Table 3. Maximum Ratings			
Parameter	Symbol	Rating	Unit
Storage Temperature	T _{store}	-55/125	∘⊂
Supply Voltage	V _{DD}	-0.6 to 6	V
Control Voltage	V _c	0/V _{DD}	V
ESD, Human Body Model	HBM	1500	V
ESD, Charged Device Model	CDM	100	V

Table 4. Environmental Compliance	
Parameter	Condition
Mechanical Shock	MIL-STD-883 Method 2002
Mechanical Vibration	MIL-STD-883 Method 2007
Temperature Cycle	MIL-STD-883 Method 1010
Solderability	MIL-STD-883 Method 2003
Fine and Gross Leak	MIL-STD-883 Method 1014
Resistance to Solvents	MIL-STD-883 Method 2015
Moisture Sensitivity Level	MSL1
Contact Pads	Gold (0.5um min - 0.8um max) over Nickel

IR Compliance

Suggested IR Profile

Devices are built using lead free epoxy and can be subjected to standard lead free IR reflow conditions shown in Table 5. Contact pads are gold over nickel and lower maximum temperatures can also be used, such as 220C.

Table 5. Reflow Profile				
Parameter	Symbol	Value		
PreHeat Time	ts	200 sec Max		
Ramp Up	R _{UP}	3°C/sec Max		
Time above 217°C	tL	150 sec Max		
Time to Peak Temperature	tAMB-P	480 sec Max		
Time at 260°C	tP	30 sec Max		
Time at 240°C	tP2	60 sec Max		
Ramp down	R _{dn}	6°C/sec Max		



Tape & Reel

Table 6. Tape and Reel Information												
Tape Dimensions (mm)				Reel Dimensions (mm)								
w	F	Do	Ро	P1	А	В	С	D	N	W1	W2	#/Reel
8.0	3.5	1.5	4.0	4.0	180	2.0	13	21.0	60.0	9.0	11.4	





Ordering Information

Table 7. Standard Frequencies (MHz)									
10.000	10.240	12.000	12.8000	14.000	14.400	16.000	16.369	16.384	16.800
19.200	20.000	24.000	25.000	25.6000	26.000	30.000	31.250	32.000	38.400
39.000	40.000	42.000	44.000	45.000	48.000	50.000	52.000		

VT-840- E F J - <u>507</u>0- xxMxxxxxx



* Add **_SNPBDIP** for tin lead solder dip Example: VT-840-EFJ-5070-26M0000000_SNPBDIP

	Revision History							
Revision Date	Approved	Description						
May 17, 2013	VN	Removed 4-pad package option and retained only the 6-pad ppackage option.						
Oct 29, 2013	VN	Updaetd Asia contact information						
Feb 11, 2014	VN	Updated Vectron Logo and Hudson address						
Sep 17, 2015	VN	Added Product Marking Information						
Jan 17, 2017	RC	Update IR Compliance						
Aug 10, 2018	FB	Update logo and contact information, add "SNPBDIP" ordering option						



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